

## IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

## Response Under 37 C.F.R. § 1.116 Expedited Procedure

In re application of: Basceri et al.

Application No. 09/965,509

Filed: September 26, 2001

Confirmation No. 3307

For: METHODS FOR FORMING AND

INTEGRATED CIRCUIT STRUCTURES CONTAINING ENHANCED-SURFACE-

AREA CONDUCTIVE LAYERS

Examiner: Toniae M. Thomas

Art Unit: 2822

Attorney Reference No. 6047-59403-01

MAIL STOP AF COMMISSIONER FOR PATENTS P.O. BOX 1450 ALEXANDRIA, VA 22313-1450

## **CERTIFICATE OF MAILING**

I hereby certify that this paper and the documents referred to as being attached or enclosed herewith are being deposited with the United States Postal Service as First Class Mail in an envelope addressed to: MAIL STOP AF, COMMISSIONER FOR PATENTS, P.O. BOX 1450, ALEXANDRIA, VA 22313-1450 on the date shown below.

Attorney for Applicant(s) U u

Date Mailed May 3, 2004

## **AMENDMENT AFTER FINAL ACTION**

This responds to the Office action dated April 21, 2004. Please amend the referenced application as follows:

Amendments to the Claims are reflected in the listing of claims, which begins on page 2.

Remarks begin on page 4.